Sipex PRODUCT CHANGE NOTICE				
PART NUMBER(S):	PCN No.: 06-0130-03			
Please see attachment.	DATE: January 30, 2006			
PART DESCRIPTION:				
Power Management and Interface Products – Change in Wafer Fabrication Site				
LEVEL OF CHANGE:				
[X] Level I, Customer Approval.	[] Level II, Customer Information.			
PRODUCT ATTRIBUTE AFFECTED:				
[] Material Change[] Design Change[X] Process Change	[] Data Sheet Change[] Package Change[] Packing / Shipping			
[X] Other, Explain: Wafer Fabrication Site Transfer				
DESCRIPTION OF CHANGE:				
Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry SILAN. See attached Product List no. 03.				
REASON FOR CHANGE:				
Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.				
-	PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE): June 25, 2006			

^{*} Samples representative of product from the Product Family being transferred.



	PRODUCT CHANGE NOTICE				
EARLIEST DATE OF PRODUC SHIPMENTS: October 16, 200	_				
EFFECTIVITY CHANGE DATE	OR DATE CODE: Work we	ek associated with earliest	production shipment.		
[] STANDARD DISTRIBUT	ION	[х] сизтом	DISTRIBUTION		
PERSON TO CONTACT WITH	QUESTIONS:				
Fred Claussen					
VP Quality Assurance and Relia Sipex Corporation Phone Number: 408-935-7644 FAX NUMBER: 408-935-7678	ability				



PRODUCT CHANGE NOTICE

PCN No.: 06-0130-03

List 3

SP3203CA

SP3203CA-L

SP3203CY

SP3203CY-L

SP3203EA

SP3203EA-L

SP3203ECA

SP3203ECA-L

SP3203ECY

SP3203ECY-L

SP3203EEA

SP3203EEA-L

SP3203EEY

SP3203EEY-L

SP3203EY

SP3203EY-L